

SN54LS651 THRU SN54LS653 SN74LS651 THRU SN74LS653 OCTAL BUS TRANSCEIVERS AND REGISTERS

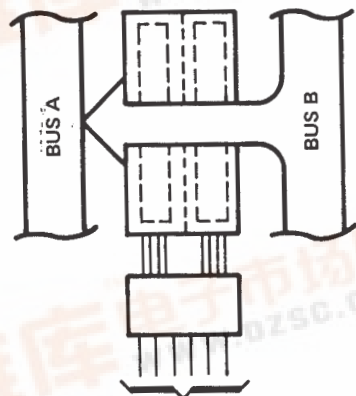
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- **Bus Transceivers/Registers**
- **Independent Registers and Enables for A and B Buses**
- **Multiplexed Real-Time and Stored Data**
- **Choice of True and Inverting Data Paths**
- **Choice of 3-State or Open-Collector Outputs to A Bus**
- **Dependable Texas Instruments Quality and Reliability**

DEVICE	A OUTPUT	B OUTPUT	LOGIC
'LS651	3-State	3-State	Inverting
'LS652	3-State	3-State	True
'LS653	Open-collector	3-State	Inverting

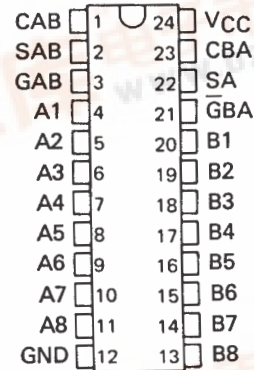
description

These devices consist of bus transceiver circuits, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the data bus or from the internal storage registers. Enable GAB and $\overline{\text{GBA}}$ are provided to control the transceiver functions. SAB and SBA control pins are provided to select whether realtime or stored data is transferred. A low input level selects real-time data, and a high selects stored data. The following examples demonstrate the four fundamental bus-management functions that can be performed with the 'LS651, 'LS652, and 'LS653.

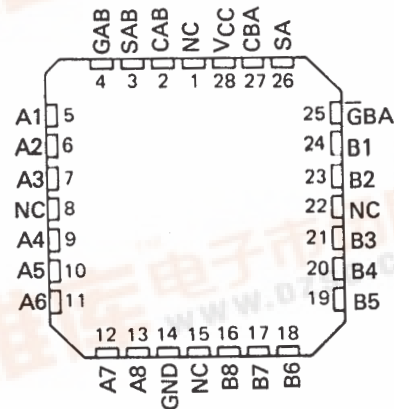


REAL-TIME TRANSFER
BUS B TO BUS A

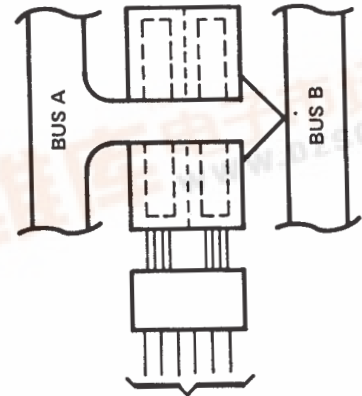
SN54LS' . . . JT PACKAGE
SN74LS' . . . DW OR NT PACKAGE
(TOP VIEW)



SN54LS' . . . FK PACKAGE
(TOP VIEW)



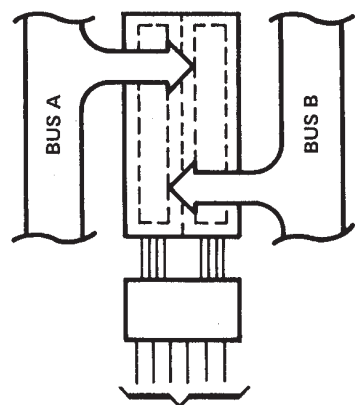
NC — No internal connection



REAL-TIME TRANSFER
BUS A TO BUS B

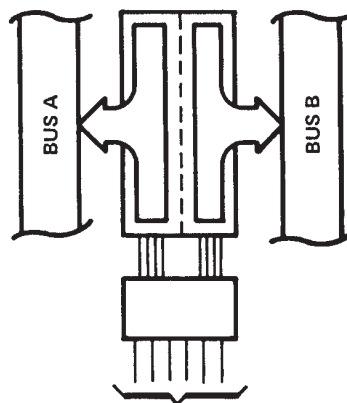
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GAB	$\overline{\text{GBA}}$	CAB	CBA	SAB	SBA
X	H	↑	X	X	X
L	X	X	↑	X	X
L	H	↑	↑	X	X

STORAGE FROM
A AND/OR B



GAB	$\overline{\text{GBA}}$	CAB	CBA	SAB	SBA
H	L	H or L	H or L	H	H

TRANSFER
STORED DATA
TO A AND/OR B

Data on the A or B data bus, or both, can be stored in the internal D flip-flop by low-to-high transitions at the appropriate clock pins (CAB or CBA) regardless of the select or enable control pins. When SAB or SBA are in the real-time transfer mode, it is also possible to store data without using the internal D-type flip-flops by simultaneously enabling GAB and $\overline{\text{GBA}}$. In this configuration each output reinforces its input. Thus, when all other data sources to the two sets of bus lines are at high impedance, each set of bus lines will remain at its last state.

The SN54LS651 through SN54LS653 are characterized for operation over the full military temperature range of -55°C to 125°C . The SN74LS651 through SN74LS653 are characterized for operation from 0°C to 70°C .

FUNCTION TABLE

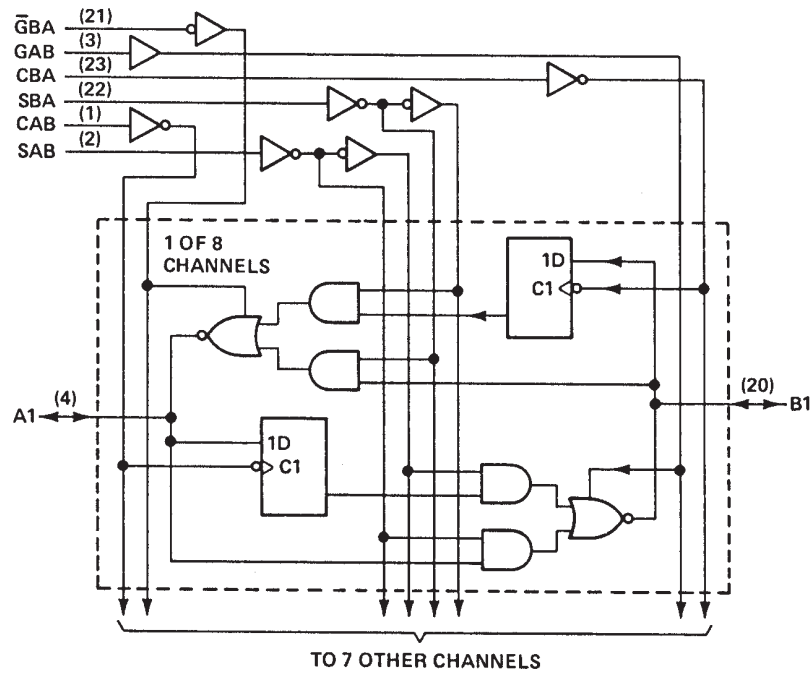
INPUTS						DATA I/O*		OPERATION OR FUNCTION	
GAB	$\overline{\text{GBA}}$	CAB	CBA	SAB	SBA	A1 THRU A8	B1 THRU B8	'LS651, 'LS653	'LS652, 'LS654
L	H	H or L	H or L	X	X	Input	Input	Isolation	Isolation
L	H	↑	↑	X	X			Store A and B Data	Store A and B Data
X	H	↑	H or L	X	X	Input	Not specified	Store A, Hold B	Store A, Hold B
H	H	↑	↑	X	X	Input	Output	Store A in both registers	Store A in both registers
L	X	H or L	↑	X	X	Not specified	Input	Hold A, Store B	Hold A, Store B
L	L	↑	↑	X	X	Output	Input	Store B in both registers	Store B in both registers
L	L	X	X	X	L	Output	Input	Real-Time $\overline{\text{B}}$ Data to A Bus	Real-Time B Data to A Bus
L	L	X	H or L	X	H			Stored $\overline{\text{B}}$ Data to A Bus	Stored B Data to A Bus
H	H	X	X	L	X	Input	Output	Real-Time $\overline{\text{A}}$ Data to B Bus	Real-Time A Data to B Bus
H	H	H or L	X	H	X			Stored $\overline{\text{A}}$ Data to B Bus	Stored A Data to B Bus
H	L	H or L	H or L	H	H	Output	Output	Stored $\overline{\text{A}}$ Data to B Bus and Stored $\overline{\text{B}}$ Data to A Bus	Stored A Data to B Bus and Stored B Data to A Bus

* The data output functions may be enabled or disabled by various signals at the GAB and $\overline{\text{GBA}}$ inputs. Data input functions are always enabled, i.e., data at the bus pins will be stored on every low-to-high transition on the clock inputs.

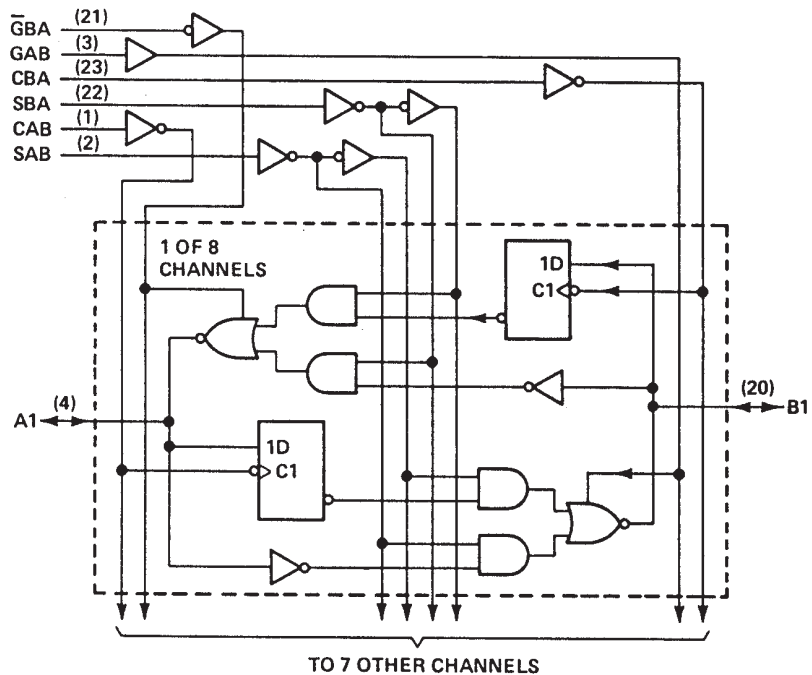
SN54LS651 THRU SN54LS653
SN74LS651 THRU SN74LS653
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logic diagrams (positive logic)

'LS651, 'LS653



'LS652

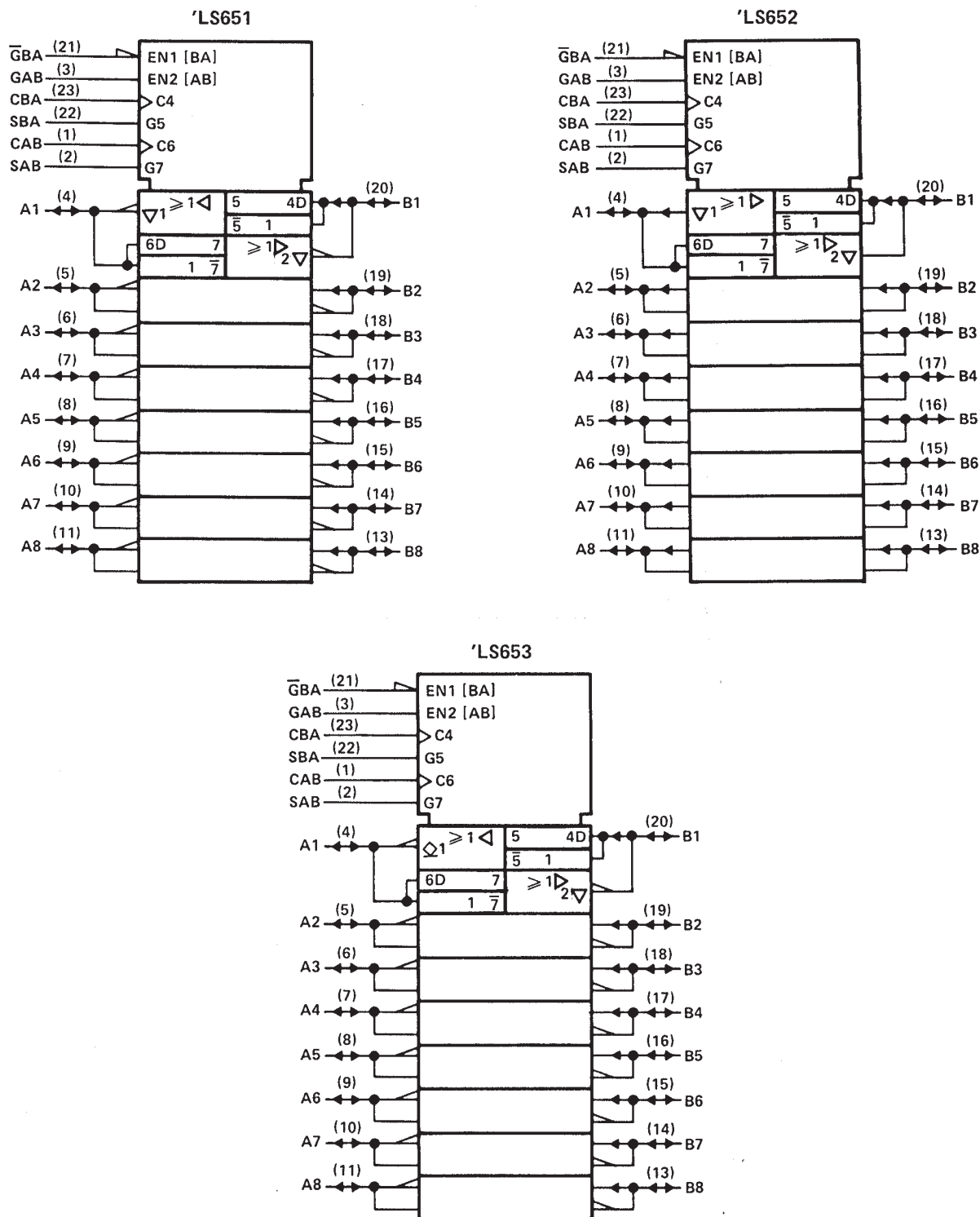


Pin numbers shown are for DW, JT or NT packages.

SN54LS651 THRU SN54LS653 SN74LS651 THRU SN74LS653 OCTAL BUS TRANSCEIVERS AND REGISTERS

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logic symbols†



†This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.
Pin numbers shown are for DW, JT, or NT packages.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC}	7 V
Input voltage: Control inputs	7 V
I/O ports	5.5 V
Operating free-air temperature range: SN54LS651, SN54LS652	– 55°C to 125°C
SN74LS651, SN74LS652	0°C to 70°C
Storage temperature range	– 65°C to 150°C

recommended operating conditions

		SN54LS651 SN54LS652			SN74LS651 SN74LS652			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH}	High-level input voltage	2			2			V
V _{IL}	Low-level input voltage			0.7			0.8	V
I _{OH}	High-level output current			− 12			− 15	mA
I _{OL}	Low-level output current			12			24	mA
t _w	Pulse duration	CBA or CAB high		15	15		ns	
		CBA or CAB low		15	15			
		Data high or low		15	15			
t _{su}	Setup time before CAB ↑ or CBA ↑	A or B		15	15		ns	
t _h	Hold time after CAB ↑ or CBA ↑	A or B		0	0		ns	
T _A	Operating free-air temperature	− 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		SN54LS651 SN54LS652		SN74LS651 SN74LS652		UNIT
				MIN	TYP‡	MAX	MIN	
V _{IK}		V _{CC} = MIN, I _I = − 18 mA		− 1.5		− 1.5		V
V _{OH}		V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = MAX,	I _{OH} = − 3 mA	2.4	3.4	2.4	3.4	V
			I _{OH} = − 12 mA	2				
			I _{OH} = − 15 mA			2		
V _{OL}		V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = MAX,	I _{OL} = 12 mA	0.25	0.4	0.25	0.4	V
			I _{OL} = 24 mA			0.35 0.5		
I _I	Control inputs	V _{CC} = MAX, V _I = 7 V		0.1		0.1		mA
	A or B ports	V _{CC} = MAX, V _I = 5.5 V		0.1		0.1		
I _{IH}	Control inputs	V _{CC} = MAX, V _I = 2.7 V		20		20		μA
	A or B ports¶			20		20		
I _{IL}	Control inputs	V _{CC} = MAX, V _I = 0.4 V		− 0.4		− 0.4		mA
	A or B ports¶			− 0.4		− 0.4		
I _{OS} §		V _{CC} = MAX, V _O = 0 V		− 40	− 225	− 40	− 225	mA
I _{CC}	LS651	V _{CC} = MAX	Outputs high	95	145	95	145	mA
			Outputs low	103	165	103	165	
			Outputs disabled	103	165	103	165	
	LS652		Outputs high	95	145	95	145	
			Outputs low	103	165	103	165	
			Outputs disabled	120	180	120	180	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at $V_{CC} = 5 \text{ V}, T_A = 25^\circ\text{C}$.

§ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

¶ For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.

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switching characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	'LS651			'LS652			UNIT
				MIN	TYP	MAX	MIN	TYP	MAX	
tPLH	Clock	Bus	R _L = 667 Ω, C _L = 45 pF, See Note 2		14	24		15	25	ns
tPHL					23	35		24	36	ns
tPLH	Bus	Bus			9	18		12	18	ns
tPHL					20	30		13	20	ns
tPLH	Select, with bus input high†	Bus			31	47		23	35	ns
tPHL					22	33		21	32	ns
tPLH	Select, with bus input low†	Bus			23	35		33	50	ns
tPHL					19	30		15	23	ns
tPZH	G̅BA	A Bus			29	44		30	45	ns
tPZL					40	60		36	54	ns
tPZH	GAB	B Bus			19	29		20	30	ns
tPZL					26	40		25	38	ns
tPHZ	G̅BA	A Bus	R _L = 667 Ω, C _L = 5 pF, See Note 2		25	38		25	38	ns
tPLZ					19	30		19	30	ns
tPHZ	GAB	B Bus			25	38		25	38	ns
tPLZ					19	30		19	30	ns

t_{PLH} = propagation delay time, low-to-high-level output.

t_{PHL} = propagation delay time, high-to-low-level output

t_{PZH} = output enable time to high level

t_{PZL} = output enable time to low level

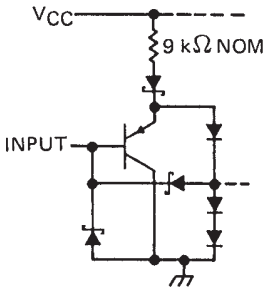
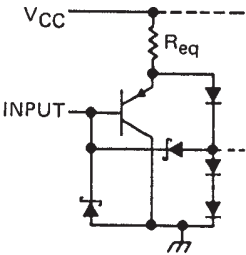
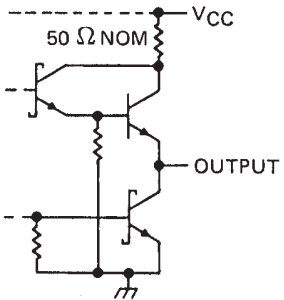
t_{PHZ} = output disable time from high level

t_{PLZ} = output disable time from low level

[†] These parameters are measured with the internal output state of the storage register opposite to that of the bus input.

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

schematics of inputs and outputs

EQUIVALENT OF GAB INPUTS	EQUIVALENT OF ALL OTHER INPUTS	TYPICAL OF ALL OUTPUTS
	 <p>A and B: $R_{eq} = 15\text{ k}\Omega\text{ NOM}$ $\overline{\text{GBA}}$, CAB and CBA: $R_{eq} = 10\text{ k}\Omega\text{ NOM}$ SAB and SBA: $R_{eq} = 6\text{ k}\Omega\text{ NOM}$</p>	

SN54LS653, SN74LS653

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} 7 V

Input voltage: All inputs and A I/O ports 7V

B I/O ports	5.5 V
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Operating free-air temperature range: SN54LS653 -55°C to 125°C

SN74LS653 0°C to 70°C

Storage temperature range -65°C to 150°C

recommended operating conditions

			SN54LS653			SN74LS653			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage		4.5	5	5.5	4.75	5	5.25	V
V _{IH}	High-level input voltage		2			2			V
V _{IL}	Low-level input voltage		0.7			0.8			V
V _{OH}	High-level output voltage	A ports	5.5			5.5			V
I _{OH}	High-level output current	B ports	− 12			− 15			mA
I _{OL}	Low-level output current		12			24			mA
t _w	Pulse duration	CBA or CAB high	15			15			ns
		CBA or CAB low	30			30			
		Data high or low	30			30			
t _{su}	Setup time before CAB ↑ or CBA ↑	A or B	15			15			ns
t _h	Hold time after CAB ↑ or CBA ↑	A or B	0			0			ns
T _A	Operating free-air temperature		− 55 125			0 70			°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		SN54LS653		SN74LS653		UNIT
				MIN	TYP‡	MAX	MIN	
V _{IK}		V _{CC} = MIN, I _I = − 18 mA		− 1.5		− 1.5		V
V _{OH}	B ports	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = MAX	I _{OH} = − 3 mA	2.4	3.4	2.4	3.4	V
			I _{OH} = − 12 mA	2				
			I _{OH} = − 15 mA			2		
I _{OH}	A ports	V _{CC} = MIN, V _{OH} = 5.5 V		0.1		0.1		mA
V _{OL}		V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = MAX	I _{OL} = 12 mA	0.25	0.4	0.25	0.4	V
			I _{OL} = 24 mA			0.35 0.5		
I _I	Control inputs	V _{CC} = MAX, V _I = 7 V		0.1		0.1		mA
	A or B ports	V _{CC} = MAX, V _I = 5.5 V		0.1		0.1		
I _{IH}	Control inputs	V _{CC} = MAX, V _I = 2.7 V		20		20		μA
	A or B ports†			20		20		
I _{IL}	Control inputs	V _{CC} = MAX, V _I = 0.4 V		− 0.4		− 0.4		mA
	A or B ports†			− 0.4		− 0.4		
I _{OS} §	B ports	V _{CC} = MAX, V _O = 0 V		− 40	− 225	− 40	− 225	mA
I _{CC}	LS653	V _{CC} = MAX	Outputs high	95	145	95	145	mA
			Outputs low	103	165	103	165	
			Outputs disabled	103	165	103	165	
	LS654		Outputs high	95	145	95	145	
			Outputs low	105	170	105	170	
			Outputs disabled	120	180	120	180	

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡] All typical values are at $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$.

⁵ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

¹ For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.

SN54LS653, SN74LS653

OCTAL BUS TRANSCEIVERS AND REGISTERS

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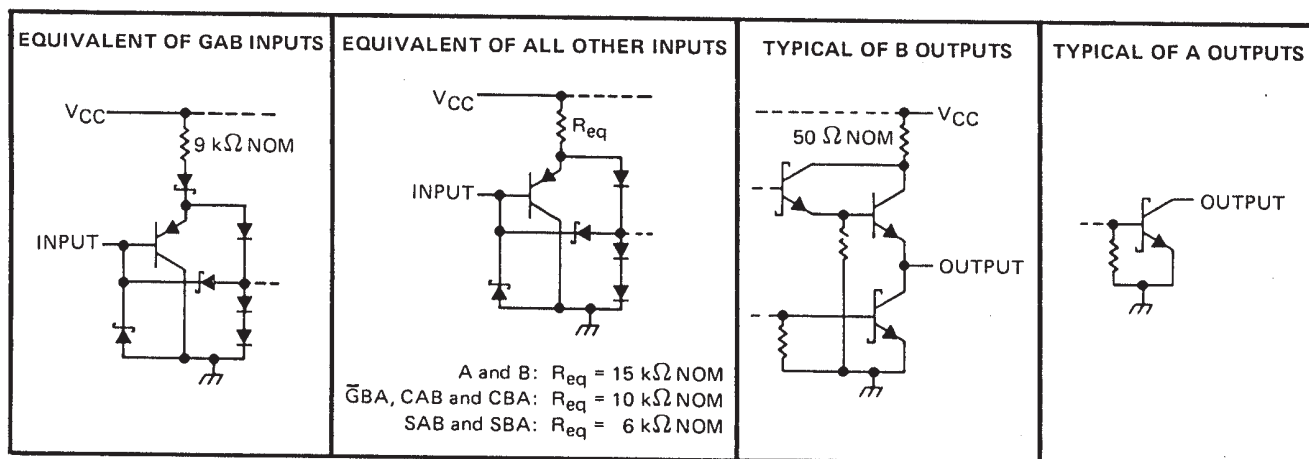
switching characteristics, $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
tPLH	CBA	A Bus	R _L = 667 Ω, C _L = 45 pF, See Note 2		25	38	ns	
tPHL					26	39		
tPLH	CAB	B Bus			15	23	ns	
tPHL					24	36		
tPLH	A Bus	B Bus			10	18	ns	
tPHL					20	30		
tPLH	B Bus	A Bus			21	32	ns	
tPHL					16	24		
tPLH	SBA† (with B high)	A Bus			38	57	ns	
tPHL					26	39		
tPLH	SBA† (with B low)	A Bus			34	51	ns	
tPHL					23	35		
tPLH	SAB† (with A high)	B Bus			32	48	ns	
tPHL					22	33		
tPLH	SAB† (with A low)	B Bus			24	36	ns	
tPHL					20	30		
tPLH	GBA	A Bus			23	35	ns	
tPHL					37	55		
tPZH	GAB	B Bus		R _L = 667 Ω, C _L = 5 pF, See Note 2		19	29	ns
tPZL						25	38	
tPHZ	GAB	B Bus			26	39	ns	
tPLZ					19	29		

[†]These parameters are measured with the internal output state of the storage register opposite to that of the bus input.

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

schematics of inputs and outputs



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